1. General description

Automotive qualified N-channel MOSFET using the latest Trench 9 low ohmic superjunction technology, housed in a robust LFPAK56 package. This product has been fully designed and qualified to meet AEC-Q101 requirements delivering high performance and endurance.

2. Features and benefits

- Fully automotive qualified to AEC-Q101:
 - 175 °C rating suitable for thermally demanding environments
- Trench 9 Superjunction technology:
 - Reduced cell pitch enables enhanced power density and efficiency with lower $R_{\mbox{\scriptsize DSon}}$ in same footprint
 - Improved SOA and avalanche capability compared to standard TrenchMOS
 - Tight V_{GS(th)} limits enable easy paralleling of MOSFETs
- LFPAK Gull Wing leads:
 - High Board Level Reliability absorbing mechanical stress during thermal cycling, unlike traditional QFN packages
 - Visual (AOI) soldering inspection, no need for expensive x-ray equipment
 - · Easy solder wetting for good mechanical solder joint
- LFPAK copper clip technology:
 - Improved reliability, with reduced R_{th} and R_{DSon}
 - · Increases maximum current capability and improved current spreading

3. Applications

- 12 V automotive systems
- · Motors, lamps and solenoid control
- · Start-Stop micro-hybrid applications
- · Transmission control
- Ultra high performance power switching

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|------------------|-------------------------|--|-----|-----|-----|-----|------|
| V_{DS} | drain-source voltage | 25 °C ≤ T _j ≤ 175 °C | | - | - | 40 | V |
| I _D | drain current | V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u> | [1] | - | - | 190 | Α |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; <u>Fig. 1</u> | | - | - | 395 | W |



| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|-------------------|----------------------------------|--|--|------|------|-----|------|
| Static chara | cteristics | | | | | | |
| R _{DSon} | drain-source on-state resistance | V_{GS} = 10 V; I_{D} = 25 A; T_{j} = 25 °C; Fig. 11 | | 0.74 | 1.06 | 1.4 | mΩ |
| Dynamic ch | Dynamic characteristics | | | | | | _ |
| Q_{GD} | gate-drain charge | I _D = 25 A; V _{DS} = 32 V; V _{GS} = 10 V; Fig. 13; Fig. 14 | | - | 13.4 | 27 | nC |
| Source-drai | n diode | | | | | • | |
| Q _r | recovered charge | I_S = 25 A; dI_S/dt = -100 A/ μ s; V_{GS} = 0 V; V_{DS} = 20 V | | - | 39 | - | nC |
| S | softness factor | I_S = 25 A; dI_S/dt = -100 A/ μ s; V_{GS} = 0 V; V_{DS} = 20 V; T_j = 25 °C; Fig. 17 | | - | 0.7 | - | |

^{[1] 190}A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-----------------------------------|--|----------------|
| 1 | S | source | mb | D |
| 2 | S | source | | |
| 3 | S | source | | G P |
| 4 | G | gate | | mbb076 S |
| mb | D | mounting base; connected to drain | 1 2 3 4 LFPAK56; Power- SO8 (SOT669) | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | | | |
|--------------|-----------------------|--|---------|--|--|
| | Name | Description | Version | | |
| BUK7Y1R4-40H | LFPAK56; Power-SO8 | plastic, single-ended surface-mounted package; 4 terminals | SOT669 | | |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|--------------|--------------|
| BUK7Y1R4-40H | 71H440 |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|----------------------|---|---|---------|-----|-----|------|
| V _{DS} | drain-source voltage | 25 °C ≤ T _j ≤ 175 °C | | - | 40 | V |
| V _{GS} | gate-source voltage | DC; T _j ≤ 175 °C | | -10 | 20 | V |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; <u>Fig. 1</u> | | - | 395 | W |
| I _D | drain current | V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u> | [1] | - | 190 | А |
| | | V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u> | [1] | - | 190 | Α |
| I _{DM} | peak drain current | pulsed; $t_p \le 10 \mu s$; $T_{mb} = 25 °C$; Fig. 3 | | - | 600 | А |
| T _{stg} | storage temperature | | | -55 | 175 | °C |
| T _j | junction temperature | | | -55 | 175 | °C |
| Source-drain d | iode | | | • | • | |
| I _S | source current | T _{mb} = 25 °C | [2] | - | 145 | А |
| I _{SM} | peak source current | pulsed; t _p ≤ 10 μs; T _{mb} = 25 °C | | - | 600 | Α |
| Avalanche rugo | gedness | | | | • | |
| E _{DS(AL)S} | non-repetitive drain- source avalanche energy | I_D = 190 A; $V_{sup} \le 40$ V; R_{GS} = 50 Ω; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; unclamped; Fig. 4 | [3] [4] | - | 154 | mJ |

 ¹⁹⁰A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

^{[2] 145}A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

^[3] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

^[4] Refer to application note AN10273 for further information.

N-channel 40 V, 1.4 m Ω standard level MOSFET in LFPAK56

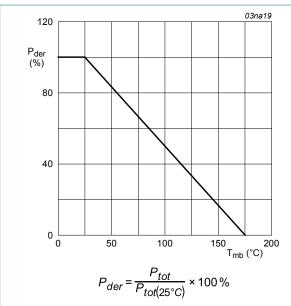
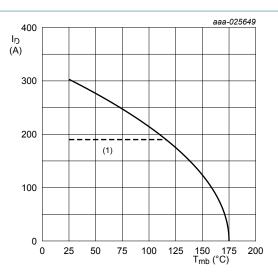


Fig. 1. Normalized total power dissipation as a function of mounting base temperature



 $V_{GS} \ge 10 \text{ V}$ (1) 190A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design

Fig. 2. Continuous drain current as a function of mounting base temperature

and operating temperature.

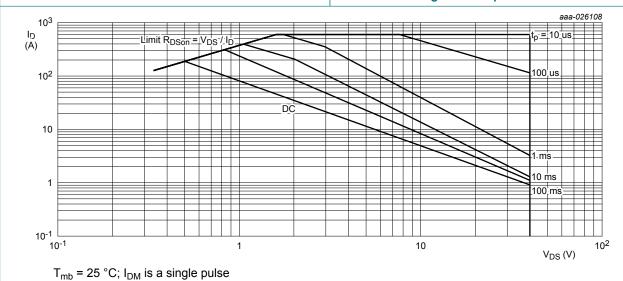
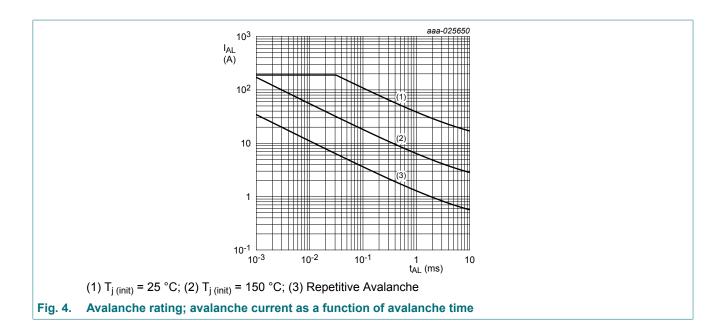


Fig. 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

N-channel 40 V, 1.4 m Ω standard level MOSFET in LFPAK56



9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---|---------------|-----|------|------|------|
| R _{th(j-mb)} | thermal resistance from junction to mounting base | <u>Fig. 5</u> | - | 0.29 | 0.38 | K/W |



10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---|----------------------------------|---|--------------------------|------|------|------|
| Static chara | acteristics | | <u> </u> | | | |
| V _{(BR)DSS} | drain-source | I _D = 250 μA; V _{GS} = 0 V; T _i = 25 °C | 40 | 42 | - | V |
| V _{GS(th)} I _{DSS} I _{GSS} | breakdown voltage | I _D = 250 μA; V _{GS} = 0 V; T _j = -40 °C | - | 39.6 | - | V |
| | | I _D = 250 μA; V _{GS} = 0 V; T _i = -55 °C | 36 | 38.9 | - | V |
| V _{GS(th)} | gate-source threshold voltage | I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C; <u>Fig. 9</u> ; <u>Fig. 10</u> | 2.4 | 3 | 3.6 | V |
| | | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}; Fig. 9$ | - | - | 4.3 | V |
| | | I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; <u>Fig. 9</u> | 1 | - | - | V |
| I _{DSS} | drain leakage current | V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C | - | 0.1 | 12 | μA |
| | | V _{DS} = 16 V; V _{GS} = 0 V; T _j = 125 °C | - | 2.4 | 10 | μΑ |
| | | V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C | - | 240 | 500 | μA |
| I _{GSS} | gate leakage current | V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C | - | 2 | 100 | nA |
| | | V _{GS} = -10 V; V _{DS} = 0 V; T _i = 25 °C | - 2 100 0.74 1.06 1.4 | nA | | |
| DOON | drain-source on-state resistance | V_{GS} = 10 V; I_{D} = 25 A; T_{j} = 25 °C; Fig. 11 | 0.74 | 1.06 | 1.4 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 105 °C; Fig. 12 | 1.05 | 1.57 | 2.23 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 125 °C; Fig. 12 | 1.16 | 1.74 | 2.45 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; Fig. 12 | 1.46 | 2.18 | 3.05 | mΩ |
| R_G | gate resistance | f = 1 MHz; T _j = 25 °C | 0.4 | 1 | 2.5 | Ω |
| Dynamic ch | naracteristics | | | | ' | |
| Q _{G(tot)} | total gate charge | I _D = 25 A; V _{DS} = 32 V; V _{GS} = 10 V; | - | 73 | 103 | nC |
| Q _{GS} | gate-source charge | Fig. 13; Fig. 14 | - | 21 | 32 | nC |
| Q _{GD} | gate-drain charge |] | - | 13.4 | 27 | nC |
| C _{iss} | input capacitance | V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz; | - | 5436 | 7610 | pF |
| C _{oss} | output capacitance | T _j = 25 °C; <u>Fig. 15</u> | - | 1314 | 1840 | pF |
| C _{rss} | reverse transfer capacitance | | - | 238 | 524 | pF |
| t _{d(on)} | turn-on delay time | $V_{DS} = 30 \text{ V}; R_L = 1.2 \Omega; V_{GS} = 10 \text{ V};$ | - | 19 | - | ns |
| t _r | rise time | $R_{G(ext)} = 5 \Omega$ | - | 17 | - | ns |
| $t_{d(off)}$ | turn-off delay time | 1 | - | 43 | - | ns |
| t _f | fall time | 1 | - | 21 | - | ns |
| Source-dra | in diode | | | | 1 | |
| V _{SD} | source-drain voltage | I _S = 25 A; V _{GS} = 0 V; T _i = 25 °C; <u>Fig. 16</u> | - | 0.8 | 1.2 | V |

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|-----------------------|---|-----|------|-----|------|
| t _{rr} | reverse recovery time | $I_S = 25 \text{ A}; dI_S/dt = -100 \text{ A/µs}; V_{GS} = 0 \text{ V};$ | - | 37 | - | ns |
| Q _r | recovered charge | V _{DS} = 20 V | - | 39 | - | nC |
| S | softness factor | $I_S = 25 \text{ A}; dI_S/dt = -100 \text{ A/}\mu\text{s}; V_{GS} = 0 \text{ V}; V_{DS} = 20 \text{ V}; T_j = 25 ^{\circ}\text{C}; Fig. 17$ | - | 0.7 | - | |
| | | I_S = 25 A; dI_S/dt = -500 A/ μ s; V_{GS} = 0 V; V_{DS} = 20 V; T_j = 25 °C; Fig. 17 | - | 0.56 | - | |

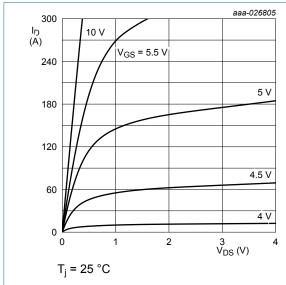


Fig. 6. Output characteristics; drain current as a function of drain-source voltage; typical values

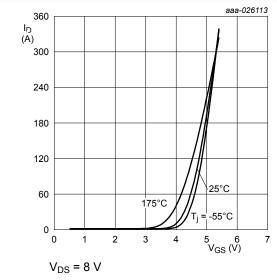


Fig. 8. Transfer characteristics; drain current as a function of gate-source voltage; typical values

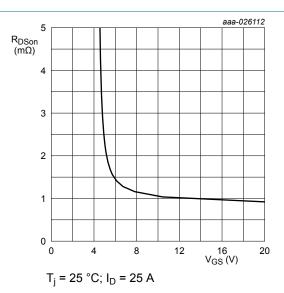


Fig. 7. Drain-source on-state resistance as a function of gate-source voltage; typical values

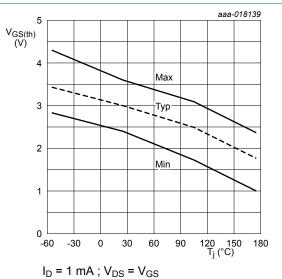


Fig. 9. Gate-source threshold voltage as a function of junction temperature

N-channel 40 V, 1.4 m Ω standard level MOSFET in LFPAK56

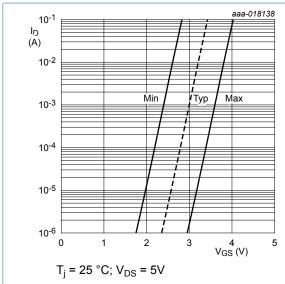


Fig. 10. Sub-threshold drain current as a function of gate-source voltage

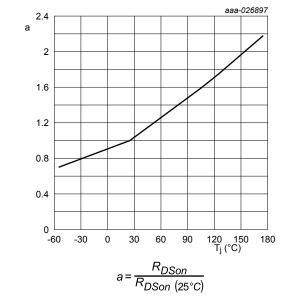


Fig. 12. Normalized drain-source on-state resistance factor as a function of junction temperature

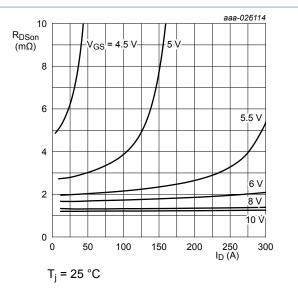


Fig. 11. Drain-source on-state resistance as a function of drain current; typical values

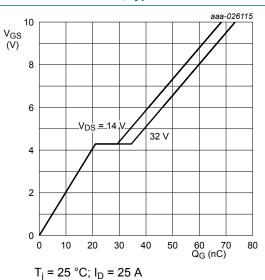


Fig. 13. Gate-source voltage as a function of gate charge; typical values

N-channel 40 V, 1.4 m Ω standard level MOSFET in LFPAK56

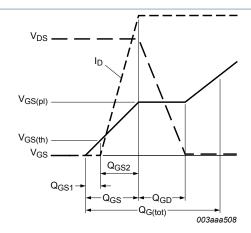
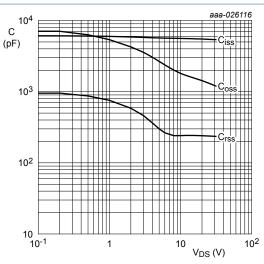


Fig. 14. Gate charge waveform definitions



 $V_{GS} = 0 V$; f = 1 MHz

Fig. 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

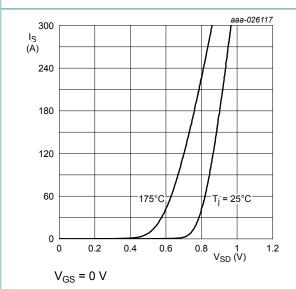
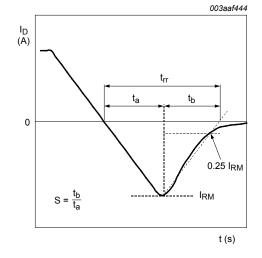


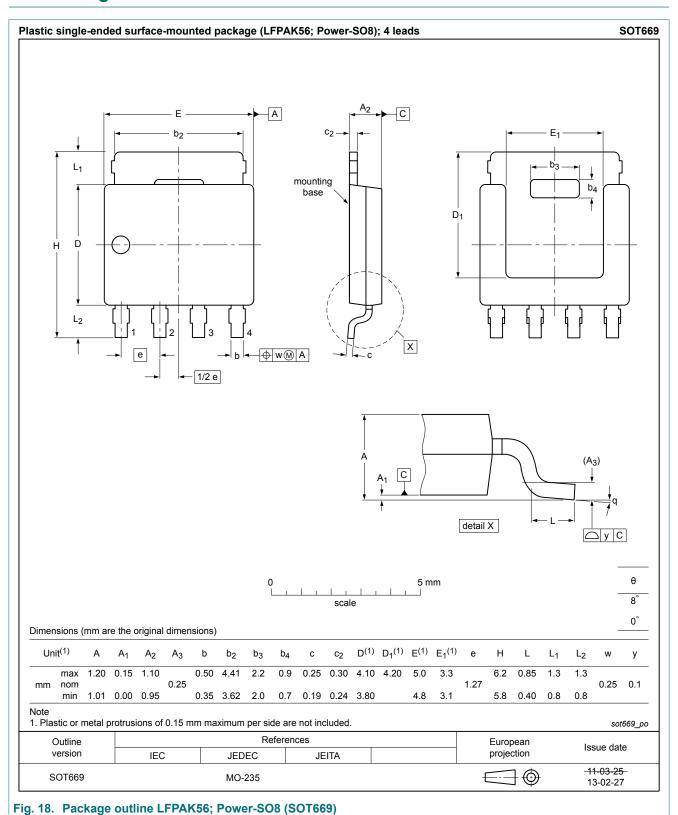
Fig. 16. Source-drain (diode forward) current as a function of source-drain (diode forward) voltage; typical values



 $t_{rr} = t_a + t_b$

Fig. 17. Reverse recovery waveform definitions

11. Package outline



12. Legal information

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|--------------------------------|--------------------|---|
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